

PT6000/7000 Series

SLTA005A

(Revised 6/30/2000)

PT6000/7000 Series Capacitor Recommendations

The selection of input and output capacitor types is determined by ripple current, transient response, equivalent series resistance (ESR), and temperature ratings. At temperatures below (0°C), we recommend tantalum and Oscon-type capacitors on the input bus. At these lower temperatures, aluminum electrolytic capacitors have significant capacitance degradation and do not provide adequate ripple filtering.

NOTE: The Oscon SS Series is not recommended for the output bus. Oscon SS and organic semiconductive electrolyte type capacitors have extremely low ESR and high ripple current capability which can cause output instability. These capacitors are recommended only for the input bus.

The minimum recommended input capacitors for the PT6000/7000 series are shown in Table 4A. The recommended low ESR capacitors are listed in Table 4B. For some products, parallel input caps are required to meet ripple current requirements.

Table 4A

| PT6000/7000 SERIES INPUT/OUTPUT CAPACITANCE | | | | |
|---|----------------------------|------------------------------|-----------------------------|--|
| | Input Capacitor | | | |
| Product Series | Capacitor Value (µF) | Ripple Current (mArms) | Output Capacitor (µF) | |
| PT6500/6600 | 330 | 600 | 330 | |
| РТ6620/РТ6650 | 330/100 | 500 | 330 | |
| PT7601/7705 | 1200 | 1300 | 1200 | |
| PT7720 | 560 | 4000 | 1200 | |
| PT7750 | 560 | 8000 | 2000 | |

Table 4B

| PT6500/6600 SERIES ESR RECOMMENDED CAPACITORS | | | | | |
|---|------------------|---------------|---------------|---------------------------------------|--|
| Supplier Series | Working Volts | Value (µF) | ESR (Ohms) | Max Ripple Current (mArms@85°C) | |
| Panasonic FA | 10 | 390 | 0.117 | 950 | |
| | 10 | 1500 | 0.045 | 1400 | |
| | 25 | 390 | 0.068 | 950 | |
| | 35 | 150 | 0.117 | 555 | |
| | 50 | 150 | 0.119 | 740 | |
| United Chemi-Con LXF/L | V 10 | 390 | 0.12 | 625 | |
| | 10 | 1500 | 0.044 | 1440 | |
| | 25 | 330 | 0.084 | 825 | |
| | 35 | 120 | 0.12 | 625 | |
| | 50 | 120 | 0.12 | 755 | |
| Nichicon PL | 10 | 390 | 0.13 | 950 | |
| | 10 | 1500 | 0.045 | 1440 | |
| | 25 | 390 | 0.07 | 985 | |
| | 35 | 120 | 0.15 | 550 | |
| | 50 | 150 | 0.1 | 820 | |
| Oscon SS | 10 | 330 | 0.025 | >2450 | |
| | 20 | 150 | 0.03 | >2200 | |
| AVXTantalum-TPS | 6.3 | 330 | 0.1 | >1149 | |
| | 10 | 220 | 0.1 | >2298 | |
| | 25 | 33 | 0.3 | >1989 | |
| SpragueTantalum-593D | 6.3 | 330 | 0.1 | >1280 | |
| -rB | 10 | 220 | 0.1 | >2560 | |
| | 25 | 33 | 0.225 | >2560 | |



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